



## Material Content Data Sheet



<b>Sales Product Name</b>		SPD04N80C3		<b>Issued</b>		20. July 2018		
<b>MA#</b>		MA000453248						
<b>Package</b>		PG-TO252-3-341		<b>Weight*</b>		383.21 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	3.894	1.02	1.02	10160	10160
leadframe	non noble metal	iron	7439-89-6	0.248	0.06		648	
	inorganic material	phosphorus	7723-14-0	0.075	0.02		195	
	non noble metal	copper	7440-50-8	248.124	64.76	64.84	647482	648325
wire	non noble metal	aluminium	7429-90-5	4.271	1.11	1.11	11144	11144
encapsulation	inorganic material	antimonytrioxide	1309-64-4	1.665	0.43		4346	
	plastics	brominated resin	-	1.784	0.47		4656	
	organic material	carbon black	1333-86-4	1.903	0.50		4967	
	plastics	epoxy resin	-	16.059	4.19		41905	
	inorganic material	silicondioxide	60676-86-0	97.541	25.45	31.04	254534	310408
leadfinish	non noble metal	tin	7440-31-5	3.787	0.99	0.99	9882	9882
plating	non noble metal	nickel	7440-02-0	0.515	0.13	0.13	1344	1344
solder	noble metal	silver	7440-22-4	0.084	0.02		218	
	non noble metal	tin	7440-31-5	0.067	0.02		175	
	non noble metal	lead	7439-92-1	3.198	0.83	0.87	8344	8737
*deviation	< 10%		Sum in total:			100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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